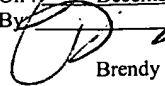


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By: 

Brendy L. Belony

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Inventor :Yoshihisa NAKAGAWA, et al.  
Filed :January 27, 2004  
For :RACK STRUCTURE BODY ...  
Serial Number :10/766,657

December 13, 2005

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**INFORMATION DISCLOSURE STATEMENT**

SIR:

In order to comply with discretionary regulations 37 CFR 1.97 and 1.98, attached hereto is a copy of Form PTO-1449 and copies of the non-US documents (if any) listed thereon. These documents contain information which the Examiner may consider to be important in deciding whether to issue a patent in the instant application.

For documents written in a language other than English, English language abstracts and/or explanations are annexed thereto explaining relevancy in accordance with 37 CFR §1.98 (a)(3).

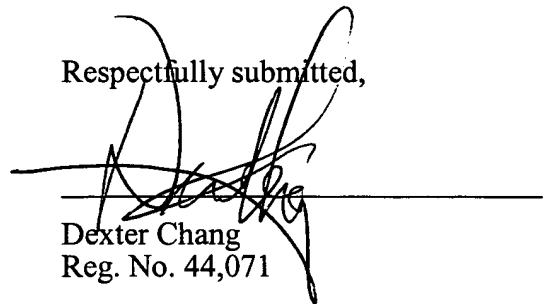
Also attached is a Chinese Office Action dated October 28, 2005, from the corresponding Chinese Application.

The present Information Disclosure Statement is being submitted in compliance with 37 §CFR 1.56 as an Examiner might consider any cited document important in deciding whether to allow the application to issue as a patent, but the citation of each document is not to be construed as an admission that such document is necessarily relevant or prior art. No representation is intended that the cited documents represent the results of a complete search, and it is anticipated that the Examiner in the normal course of examination, will make an independent search and will determine the best prior art consistent with 37 CFR 1.104 (a), and in the course of such search will review for relevance every document cited on the attached form even if not initialed.

Each item of information contained in the information disclosure statement was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the information disclosure statement, thus no fee is due.

Early and favorable consideration is respectfully solicited.

Respectfully submitted,



Dexter Chang  
Reg. No. 44,071

Customer Number: 026304  
Docket No.: FUJI 20.903

Patent and Trademark Office U.S. DEPARTMENT OF COMMERCE

DEC 13 2005

Patent	Kind Code	Name of Patentee or
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if known <sup>2</sup>	of Cited Document
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Country	Name of Patentee
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of Cited Document
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Examiner	Cite	Include name of the author (in CAPITAL LETTERS), t
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Initials	No.	appropriate), title of the item (book, magazine, journal,
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Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw a line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.  
 'Unique identification number' is attached to Kind of IP Rights Documents. Enter Office that issued the citation, by the two-letter code (WIPO Standard ST.3). For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.1. If possible, applicant is to place a checkmark beside English language Translation is attached Burden Hour Statement: This form is estimated to take 2 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, Patent and Trademark Office, Washington, DC 20231. Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SFND20: Assistant Commissioner for Patents, Washington, DC 20231.